

RD06HHF1

RoHS Compliance, Silicon MOSFET Power Transistor 30MHz, 6W, 12.5V

DESCRIPTION

RD06HHF1 is a MOS FET type transistor specifically designed for HF RF power amplifiers applications.

FEATURES

High power gain:

Pout>6W, Gp>16dB @Vdd=12.5V,f=30MHz

Integrated gate protection diode

APPLICATION

For output stage of high power amplifiers in HF band mobile radio sets.

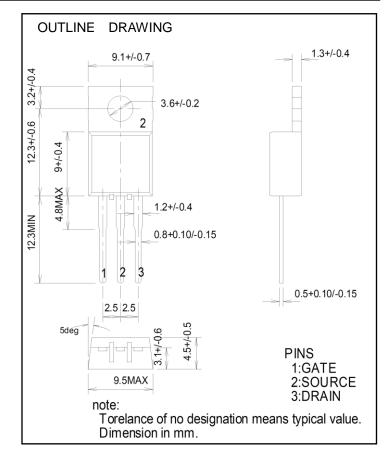
Rohs Compliant

RD06HHF1-501 is a RoHS compliant products.

This product includes the lead in high melting temperature type solders.

However, it is applicable to the following exceptions of RoHS Directions.

1. Lead in high melting temperature type solders (i.e.tin-lead solder alloys containing more than 85% lead.)



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ABSOLUTE MAXIMUM RATINGS

(Tc=25°C UNLESS OTHERWISE NOTED)

SYMBOL	PARAMETER	CONDITIONS	RATINGS	UNIT
VDSS	Drain to source voltage	Vgs=0V	50	V
Vgss	Gate to source voltage	Vds=0V	-5/+10	V
Pch	Channel dissipation	Tc=25°C	27.8	W
Pin	Input power	Zg=Zl=50Ω	0.3	W
ID	Drain current	-	3	Α
Tch	Channel temperature	-	150	°C
Tstg	Storage temperature	-	-40 to +150	°C
Rth j-c	Thermal resistance	junction to case	4.5	°C/W

Note 1: Above parameters are guaranteed independently.

ELECTRICAL CHARACTERISTICS

(Tc=25°C, UNLESS OTHERWISE NOTED)

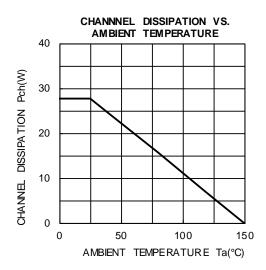
SYMBOL	PARAMETER	CONDITIONS	LIMITS			UNIT
STWIBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX.	
IDSS	Drain cutoff current	VDS=17V, VGS=0V	1	ı	10	uA
IGSS	Gate cutoff current	VGS=10V, VDS=0V	ı	ı	1	uA
VTH	Gate threshold Voltage	VDS=12V, IDS=1mA	1.9	ı	4.9	V
Pout	Output power	VDD=12.5V, Pin=0.15W,		10	-	W
ηD	Drain efficiency	f=30MHz, Idq=0.5A	55	65	-	%
	Load VSWR tolerance	V _{DD} =15.2V,Po=6W(Pin Control)	No destroy		-	
		f=30MHz,ldq=0.5A,Zg=50Ω				
		Load VSWR=20:1(All Phase)				

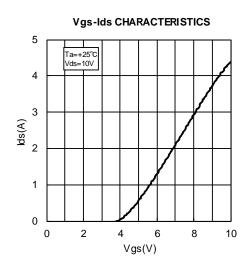
Note: Above parameters, ratings, limits and conditions are subject to change.

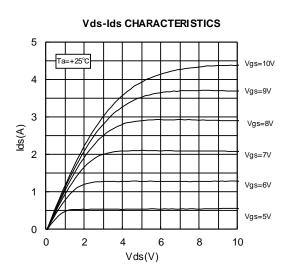
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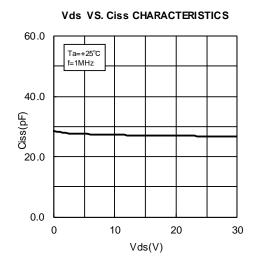
TYPICAL CHARACTERISTICS

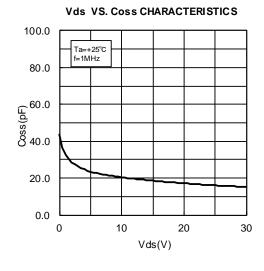
(These are only typical curves and devices are not necessarily guaranteed at these curves.)

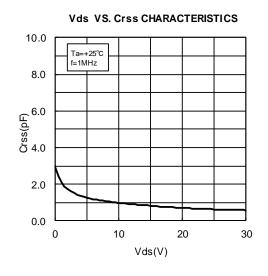








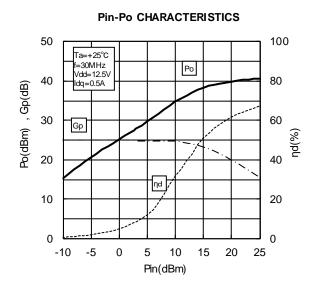


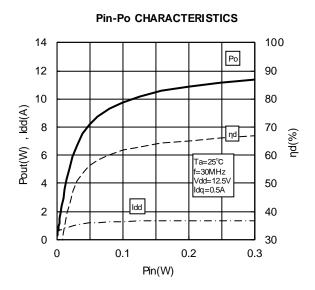


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TYPICAL CHARACTERISTICS

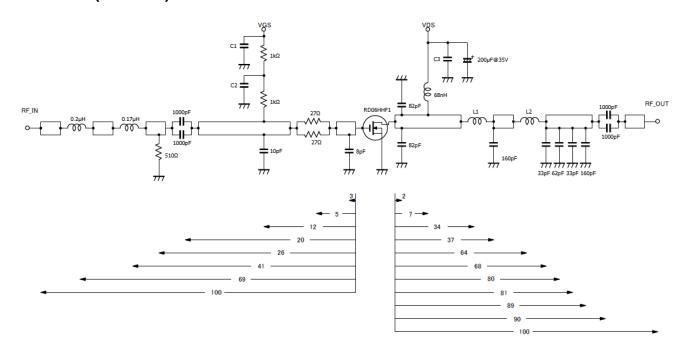
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TEST CIRCUIT(f=30MHz)

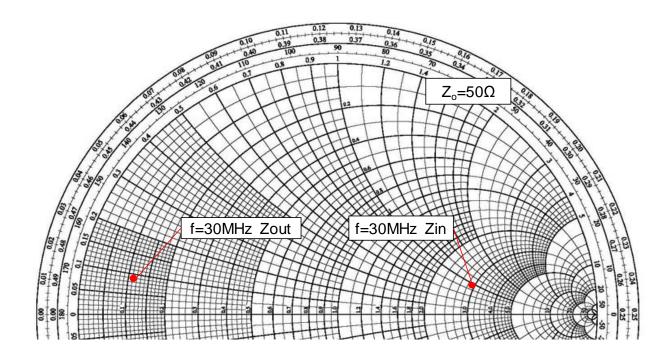


C1,C2,C3 : 100pF,1000pF,0.022 μ F,0.1 μ F in parallel L1,L2 : 8Turns,I.D5mm,D2.2mm copper wire

Dimensions : mm Note : Board material PTFE substrate micro strip line width=4.2mm/50 Ω ,er=2.7,t=1.6mm

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INPUT/OUTPUT IMPEDANCE VS.FREQUENCY CHARACTERISTICS



Zin, Zout

f	Zin	Zout	Conditions		
(MHz) (Ω)		(Ω)	Conditions		
30	144.77+j45.07	5.76+j4.87	Po=10W , Vds=12.5V , Pin=0.15W		

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RD06HHF1 S-PARAMETER DATA (@Vds=12.5V, Id=500mA)

Freq.	S	11	S	21	S12		S22	
[MHz]	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)
30	0.925	-55.8	49.826	147.6	0.015	63.9	0.787	-27.6
40	0.841	-69.4	44.143	134.5	0.018	53.2	0.721	-45.9
50	0.772	-80.3	38.820	124.7	0.019	45.7	0.664	-59.4
60	0.719	-89.4	34.224	117.0	0.020	39.8	0.621	-70.1
70	0.681	-96.6	30.413	110.8	0.020	36.0	0.588	-78.3
80	0.652	-102.8	27.245	105.6	0.021	33.3	0.562	-85.5
90	0.631	-108.1	24.623	101.1	0.020	31.4	0.543	-91.3
100	0.615	-112.6	22.402	97.0	0.020	30.0	0.532	-96.5
125	0.594	-121.7	18.113	88.6	0.020	29.4	0.517	-106.5
150	0.587	-128.0	15.093	81.9	0.018	33.3	0.522	-113.2
175	0.592	-133.3	12.896	75.9	0.018	39.0	0.528	-118.9
200	0.599	-137.8	11.184	70.5	0.017	47.5	0.543	-124.4
250	0.621	-144.8	8.698	61.1	0.019	67.1	0.583	-131.7
300	0.650	-150.6	7.056	52.5	0.025	81.3	0.615	-139.8
350	0.677	-155.8	5.841	45.2	0.033	88.9	0.661	-144.9
400	0.706	-160.5	4.923	37.6	0.043	90.6	0.687	-152.7
450	0.730	-165.0	4.222	31.5	0.054	91.0	0.726	-156.4
500	0.757	-169.6	3.619	24.6	0.065	88.8	0.743	-164.1
550	0.775	-173.7	3.184	19.6	0.078	86.9	0.778	-167.0
600	0.797	-178.0	2.766	13.6	0.089	83.3	0.783	-174.7
650	0.811	178.3	2.493	9.1	0.103	80.6	0.820	-177.0
700	0.828	174.0	2.184	3.8	0.114	76.8	0.817	175.3
750	0.842	170.6	2.008	-0.8	0.128	73.3	0.847	172.7
800	0.854	166.4	1.772	-5.2	0.138	69.6	0.839	165.4
850	0.868	163.0	1.641	-10.0	0.153	65.3	0.864	162.6
900	0.875	158.9	1.457	-13.5	0.161	62.1	0.856	155.3
950	0.889	155.7	1.359	-18.8	0.175	56.9	0.868	151.9
1000	0.893	151.5	1.214	-21.2	0.182	54.3	0.866	145.0

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ATTENTION:

- 1.High Temperature; This product might have a heat generation while operation, Please take notice that have a possibility to receive a burn to touch the operating product directly or touch the product until cold after switch off. At the near the product, do not place the combustible material that have possibilities to arise the fire.
- 2.Generation of High Frequency Power; This product generate a high frequency power. Please take notice that do not leakage the unnecessary electric wave and use this products without cause damage for human and property per normal operation.
- 3.Before use; Before use the product, Please design the equipment in consideration of the risk for human and electric wave obstacle for equipment.

PRECAUTIONS FOR THE USE OF MITSUBISHI SILICON RF POWER DEVICES:

- 1. The specifications of mention are not guarantee values in this data sheet. Please confirm additional details regarding operation of these products from the formal specification sheet. For copies of the formal specification sheets, please contact one of our sales offices.
- 2.RA series products (RF power amplifier modules) and RD series products (RF power transistors) are designed for consumer mobile communication terminals and were not specifically designed for use in other applications. In particular, while these products are highly reliable for their designed purpose, they are not manufactured under a quality assurance testing protocol that is sufficient to guarantee the level of reliability typically deemed necessary for critical communications elements and In the application, which is base station applications and fixed station applications that operate with long term continuous transmission and a higher on-off frequency during transmitting, please consider the derating, the redundancy system, appropriate setting of the maintain period and others as needed. For the reliability report which is described about predicted operating life time of Mitsubishi Silicon RF Products, please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor.
- 3. RD series products use MOSFET semiconductor technology. They are sensitive to ESD voltage therefore appropriate ESD precautions are required.
- 4. In the case of use in below than recommended frequency, there is possibility to occur that the device is deteriorated or destroyed due to the RF-swing exceed the breakdown voltage.
- 5. In order to maximize reliability of the equipment, it is better to keep the devices temperature low. It is recommended to utilize a sufficient sized heat-sink in conjunction with other cooling methods as needed (fan, etc.) to keep the channel temperature for RD series products lower than 120deg/C(in case of Tchmax=150deg/C) ,140deg/C(in case of Tchmax=175deg/C) under standard conditions.
- 6. Do not use the device at the exceeded the maximum rating condition. In case of plastic molded devices, the exceeded maximum rating condition may cause blowout, smoldering or catch fire of the molding resin due to extreme short current flow between the drain and the source of the device. These results causes in fire or injury.
- 7. For specific precautions regarding assembly of these products into the equipment, please refer to the supplementary items in the specification sheet.
- 8. Warranty for the product is void if the products protective cap (lid) is removed or if the product is modified in any way from it's original form.
- 9. For additional "Safety first" in your circuit design and notes regarding the materials, please refer the last page of this data sheet.

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- 10. Please avoid use in the place where water or organic solvents can adhere directly to the product and the environments with the possibility of caustic gas, dust, salinity, etc.
 - Reliability could be markedly decreased and also there is a possibility failures could result causing a serious accident. Likewise, there is a possibility of causing a serious accident if used in an explosive gas environment. Please allow for adequate safety margin in your designs.
- 11. Please refer to the additional precautions in the formal specification sheet.

Keep safety first in your circuit designs!

Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of non-flammable material or (iii) prevention against any malfunction or mishap.

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